



FOR IMMEDIATE RELEASE

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Tech-X Corporation Releases VORPAL v4.2.2
New release allows VORPAL users to better solve problems

Boulder, CO – June 06, 2011 - Tech-X Corporation of Boulder, Colorado, announced the release of VORPAL v4.2.2. VORPAL is a software framework that enables electromagnetic and electrostatic simulations composed of particles and fluids for 1-D, 2-D, and 3-D geometries. New capabilities will allow researchers to apply VORPAL in new application areas and enable more advanced simulations of the physics being studied.

For more information on VORPAL, please visit <http://vorpal.txcorp.com>.

About Tech-X Corporation

Tech-X Corporation is committed to technical excellence and innovation. Our technical staff addresses specific research questions and delivers quantifiable results, culminating in specialized skills, advanced technologies, and commercial products that enable large-scale computing solutions and offer a greater understanding of physical processes. Among our core competencies is the simulation of processes, devices, and physical systems related to plasma physics, fusion, and accelerator technologies, performed on computer systems ranging from desktops to Grand Challenge class high-performance computers. By creating software for simulations and the infrastructure to support our research development, we are able to increase our understanding of complex physical phenomena. For more information, visit <http://www.txcorp.com>.

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